#### TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# $\begin{array}{c} \mathsf{TD62001P}, \mathsf{TD62001AP}, \mathsf{TD62001F}, \mathsf{TD62001AF}, \mathsf{TD62002P} \\ \mathsf{TD62002AP}, \mathsf{TD62002F}, \mathsf{TD62002AF}, \mathsf{TD62003P}, \mathsf{TD62003AP}, \mathsf{TD62004P}, \mathsf{TD62004P}, \mathsf{TD62004AF} \\ \mathsf{TD62003AF}, \mathsf{TD62004P}, \mathsf{TD62004AP}, \mathsf{TD62004AF} \end{array}$

#### 7CH DARLINGTON SINK DRIVER

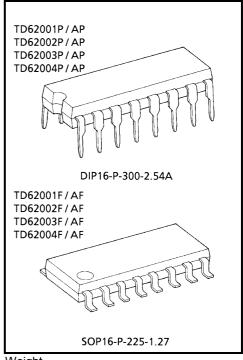
The TD62001P / AP / F / AF Series are high–voltage, high–current darlington drivers comprised of seven NPN darlington pairs. All units feature integral clamp diodes for switching inductive loads.

Applications include relay, hammer, lamp and display (LED) drivers.

#### **FEATURES**

- Output current (single output) 500 mA MAX.
- High sustaining voltage output 35 V MIN. (TD62001P / F Series) 50 V MIN. (TD62001AP / AF Series)
- Output clamp diodes
- Inputs compatible with various types of logic
- Package Type-P, AP: DIP-16 pin
- Package Type-F, AF: SOP-16 pin

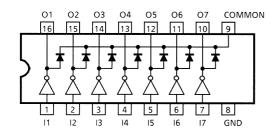
| TYPE                   | INPUT BASE<br>RESISTOR        | DESIGNATION       |
|------------------------|-------------------------------|-------------------|
| TD62001P / AP / F / AF | External                      | General Purpose   |
| TD62002P / AP / F / AF | 10.5-kΩ + 7 V<br>Zenner diode | 14~25 V PMOS      |
| TD62003P / AP / F / AF | 2.7 kΩ                        | TTL, 5 V CMOS     |
| TD62004P / AP / F / AF | 10.5 kΩ                       | 6~15 V PMOS, CMOS |



Weight

DIP16-P-300-2.54A: 1.11 g (Typ.) SOP16-P-225-1.27: 0.16 g (Typ.)

## **PIN CONNECTION (TOP VIEW)**

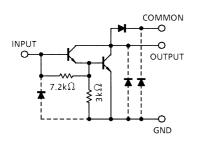


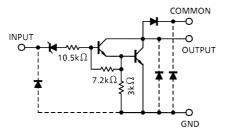
## **SCHEMATICS (EACH DRIVER)**

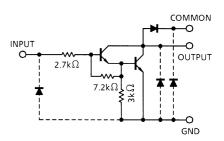
#### TD62001P / AP / F / AF

#### TD62002P / AP / F / AF

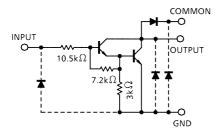
## TD62003P / AP / F / AF







#### TD62004P / AP / F / AF



Note: The input and output parasitic diodes cannot be used as clamp diodes.

## MAXIMUM RATINGS (Ta = 25°C)

| CHARACTERISTI              | SYMBOL                   | RATING                | UNIT                     |          |  |  |
|----------------------------|--------------------------|-----------------------|--------------------------|----------|--|--|
| Output Sustaining          | P, F                     | V (2)                 | -0.5~35                  | V        |  |  |
| Voltage                    | AP, AF                   | V <sub>CE</sub> (SUS) | -0.5~50                  | V        |  |  |
| Output Current             |                          | lout                  | 500                      | mA / ch  |  |  |
| Input Voltage              | V <sub>IN</sub> (Note 1) | -0.5~30               | V                        |          |  |  |
| Input Current              | I <sub>IN</sub> (Note 2) | 25                    | mA                       |          |  |  |
| Clamp Diode                | P, F                     | $V_{R}$               | 35                       | V        |  |  |
| Reverse Voltage            | AP, AF                   | VR                    | 50                       | <b>v</b> |  |  |
| Clamp Diode Forward Currer | l <sub>F</sub>           | 500                   | mA                       |          |  |  |
|                            | Р                        |                       | 1.0                      | W        |  |  |
| Power Dissipation          | AP                       | P <sub>D</sub>        | 1.47                     |          |  |  |
| ·                          | F, AF                    |                       | 0.54 / 0.625<br>(Note 3) |          |  |  |
| Operating                  | Р                        | т                     | -30~75                   | °C       |  |  |
| Temperature                | AP, F, AF                | T <sub>opr</sub>      | -40~85                   | C        |  |  |
| Storage Temperature        |                          | T <sub>stg</sub>      | -55~150                  | °C       |  |  |

Note 1: Except TD62001P / AP / F / AF Note 2: Only TD62001P / AP / F / AF

Note 3: On glass epoxy PCB (30 × 30 × 1.6 mm Cu 50%)



## RECOMMENDED OPERATING CONDITIONS

(Ta =  $-40\sim85$ °C and Ta =  $-30\sim75$ °C for only Type-P)

| CHARACTERISTIC SYMBOL         |                                     | COND                       | CONDITION  |            | TYP. | MAX | UNIT  |      |
|-------------------------------|-------------------------------------|----------------------------|--|------------|------|-----|-------|------|
| Output Sustaining             | P, F                                | V (-)                      |  |            | 0    | _   | 35    | V    |
| Voltage                       | AP, AF                              | V <sub>CE</sub> (SUS)      |  |            | 0    | _   | 50    |      |
|                               | AP                                  |                            | T <sub>pw</sub> = 25 ms<br>7 Circuits              | Duty = 10% | 0    | _   | 370   |      |
|                               | AP                                  |                            |  | Duty = 50% | 0    | _   | 130   |      |
| Output Current                | Р                                   |                            |  | Duty = 10% | 0    | _   | 295   | mA / |
| Output Current                | P                                   | lout                       | Ta = 85°C<br>T <sub>i</sub> = 120°C                | Duty = 50% | 0    | _   | 95    | ch   |
|                               | F, AF                               |                            | ., .200  | Duty = 10% | 0    | _   | 233   |      |
|                               | F, AF                               |                            |  | Duty = 50% | 0    | _   | 70    |      |
| Input Voltage                 | Except<br>TD62001P /<br>AP / F / AF | V <sub>IN</sub>            |  |            | 0    | _   | 24    | V    |
| Input Voltage<br>(Output On)  | TD62002                             | 62003 V <sub>IN (ON)</sub> |  |            | 14.5 | _   | 24    | V    |
|                               | TD62003                             |                            | I <sub>OUT</sub> = 400 mA<br>h <sub>FE</sub> = 800 | 2.8        | _    | 24  |       |      |
| (,                            | TD62004                             |                            |  |            | 6.2  | _   | 24    |      |
| Input Voltage<br>(Output Off) | TD62001                             | VIN (OFF)                  |  |            | 0    | _   | 0.6   |      |
|                               | TD62002                             |                            |  |            | 0    | _   | 7.4   | V    |
|                               | TD62003                             |                            |  |            | 0    | _   | 0.7   |      |
|                               | TD62004                             |                            |  |            | 0    | _   | 1.0   |      |
| Input Current                 | Only TD62001                        | I <sub>IN</sub>            |  |            | 0    | _   | 10    | mA   |
| Clamp Diode Reverse           | P, F                                | V-                         |  |            | -    | _   | 35    | V    |
| Voltage                       | AP, AF                              | $V_{R}$                    |  |            | -    | _   | 50    | V    |
| Clamp Diode Forward C         | urrent                              | I <sub>F</sub>             |  |            | _    | _   | 350   | mA   |
| Power Dissipation             | Р                                   |                            | Ta = 85°C  |            | _    | _   | 0.6   | W    |
|                               | AP                                  | $P_{D}$                    |  |            | _    | _   | 0.76  |      |
|                               | AF, F                               |                            | Ta = 85°C  | (Note)     | _    | _   | 0.325 |      |

3

Note: On glass epoxy PCB (30 × 30 × 1.6 mm Cu 50%)

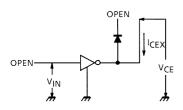


## **ELECTRICAL CHARACTERISTICS** (Ta = 25°C unless otherwise noted)

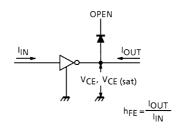
| CHARACTERIS <sup>*</sup>             | ГІС       | SYMBOL                | TEST<br>CIR-<br>CUIT | TEST CONDITION  |                              | MIN TYP. MAX |     | MAX  | UNIT |
|--------------------------------------|-----------|-----------------------|----------------------|---|------------------------------|--------------|-----|------|------|
|                                      | AD AE     |                       |                      | V <sub>CE</sub> = 50 V, Ta = 25°C                                       |                              | _            | _   | 50   |      |
|                                      | AP, AF    |                       |                      | V <sub>CE</sub> = 50 V, Ta = 85°C                                       |                              | _            | _   | 100  | μΑ   |
| Output Leakage                       |           |                       |                      | V <sub>CE</sub> = 35 V, Ta = 25°C                                       |                              | _            | _   | 50   |      |
| Current                              | F         | I <sub>CEX</sub>      | 1                    | V <sub>CE</sub> = 35 V, Ta = 85°C                                       |                              | _            | _   | 100  |      |
|                                      | -         |                       |                      | V <sub>CE</sub> = 35 V, Ta = 25°C                                       |                              | _            | _   | 50   |      |
|                                      | Р         |                       |                      | V <sub>CE</sub> = 35 V  | , Ta = 75°C                  | _            | _   | 100  |      |
|                                      |           |                       |                      | I <sub>OUT</sub> = 350 mA, I <sub>IN</sub> = 500 μA                     |                              | _            | 1.3 | 1.6  |      |
| Collector-Emitter Saturation Voltage |           | V <sub>CE (sat)</sub> | 2                    | I <sub>OUT</sub> = 200 mA, I <sub>IN</sub> = 350 μA                     |                              | _            | 1.1 | 1.3  | V    |
|                                      |           |                       |                      | I <sub>OUT</sub> = 100  | mA, I <sub>IN</sub> = 250 μA | _            | 0.9 | 1.1  |      |
| DC Current Transfer Ratio            |           | h <sub>FE</sub>       | 2                    | V <sub>CE</sub> = 2 V,  | I <sub>OUT</sub> = 350 mA    | 1000         | _   | _    |      |
|                                      | TD62002   |                       |                      | V <sub>IN</sub> = 20 V,   | I <sub>OUT</sub> = 350 mA    | _            | 1.1 | 1.7  |      |
| Input Current<br>(Output On)         | TD62003   | I <sub>IN (ON)</sub>  | 3                    | V <sub>IN</sub> = 2.4 V, I <sub>OUT</sub> = 350 mA                      |                              | _            | 0.4 | 0.7  | mA   |
| (Output On)                          | TD62004   |                       |                      | V <sub>IN</sub> = 9.5 V, I <sub>OUT</sub> = 350 mA                      |                              | _            | 0.8 | 1.2  |      |
| Input Current                        | Р         |                       |                      | I <sub>OUT</sub> = 500 μA, Ta = 75°C                                    |                              | 50           | 65  | _    | μA   |
| (Output Off)                         | AP, F, AF | I <sub>IN</sub> (OFF) | 4                    | I <sub>OUT</sub> = 500 μA, Ta = 85°C                                    |                              | 50           | 65  | _    |      |
|                                      | TD00000   | VIN (ON)              |                      | V <sub>CE</sub> = 2 V<br>h <sub>FE</sub> = 800                          | I <sub>OUT</sub> = 350 mA    | _            | _   | 13.7 | V    |
|                                      | TD62002   |                       | 5                    |   | I <sub>OUT</sub> = 200 mA    | _            | _   | 11.4 |      |
| Input Voltage                        | TD62003   |                       |                      |   | I <sub>OUT</sub> = 350 mA    | _            | _   | 2.6  |      |
| (Output On)                          |           |                       |                      |   | I <sub>OUT</sub> = 200 mA    | _            | _   | 2.0  |      |
|                                      | TDC2004   |                       |                      |   | I <sub>OUT</sub> = 350 mA    | _            | _   | 4.7  |      |
|                                      | TD62004   |                       |                      |   | I <sub>OUT</sub> = 200 mA    | _            | _   | 4.4  |      |
|                                      | AP, AF    | I <sub>R</sub>        | 6                    | V <sub>R</sub> = 50 V, Ta = 25°C  |                              | _            | _   | 50   | μΑ   |
|                                      |           |                       |                      | V <sub>R</sub> = 50 V, Ta = 85°C  |                              | _            | _   | 100  |      |
| Clamp Diode                          |           |                       |                      | V <sub>R</sub> = 35 V, Ta = 25°C  |                              | _            | _   | 50   |      |
| Reverse Current                      |           |                       |                      | V <sub>R</sub> = 35 V, Ta = 85°C  |                              | _            | _   | 100  |      |
|                                      |           |                       |                      | V <sub>R</sub> = 35 V, Ta = 25°C  |                              | _            | _   | 50   |      |
|                                      | P         |                       |                      | V <sub>R</sub> = 35 V, Ta = 75°C  |                              | _            | _   | 100  |      |
| Clamp Diode Forward Volt             | age       | V <sub>F</sub>        | 7                    | I <sub>F</sub> = 350 mA   |                              | _            | _   | 2.0  | V    |
| Input Capacitance                    |           | C <sub>IN</sub>       | _                    |   |                              | _            | 15  | _    | pF   |
| Turn-On Delay                        | P, F      | t <sub>ON</sub>       | 8                    | $V_{OUT}$ = 35 V, R <sub>L</sub> = 87.5 $\Omega$ C <sub>L</sub> = 15 pF |                              | _            | 0.1 | _    |      |
|                                      | AP, AF    | 'ON                   |                      | $V_{OUT}$ = 50 V, $R_{L}$ = 125 $\Omega$ $C_{L}$ = 15 pF                |                              | _            | 0.1 | _    | μs   |
| Turn-Off Delay                       | P, F      | toff                  | 8                    | $V_{OUT}$ = 35 V, $R_{L}$ = 87.5 $\Omega$ $C_{L}$ = 15 pF               |                              | _            | 0.2 | _    |      |
| Tani On Dolay                        | AP, AF    | *UFF                  | J                    | V <sub>OUT</sub> = 50<br>C <sub>L</sub> = 15 pF                         | V, R <sub>L</sub> = 125 Ω    | _            | 0.2 | _    |      |

## **TEST CIRCUIT**

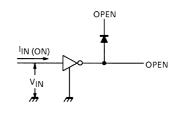
## 1. ICEX



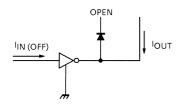
## 2. V<sub>CE (sat)</sub>, h<sub>FE</sub>



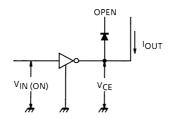
## 3. IIN (ON)



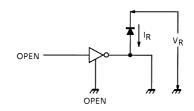
## 4. I<sub>IN (OFF)</sub>



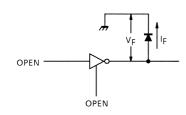
## 5. V<sub>IN (ON)</sub>



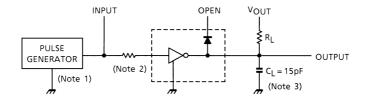
6. I<sub>R</sub>

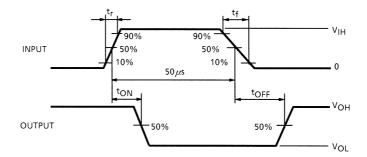


## 7. V<sub>F</sub>



## 8. ton, toff





Note 1: Pulse width 50 µs, duty cycle 10%

Output impedance 50  $\Omega$ ,  $t_r \le 5$  ns,  $t_f \le 10$  ns

Note 2: See below

#### INPUT CONDITION

| TYPE NUMBER            | R1     | V <sub>IH</sub> |
|------------------------|--------|-----------------|
| TD62001P / AP / F / AF | 2.7 kΩ | 3 V             |
| TD62002P / AP / F / AF | 0      | 13 V            |
| TD62003P / AP / F / AF | 0      | 3 V             |
| TD62004P / AP / F / AF | 0      | 8 V             |

Note 3: C<sub>L</sub> includes probe and jig capacitance.

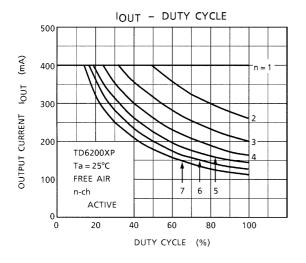
#### **PRECAUTIONS for USING**

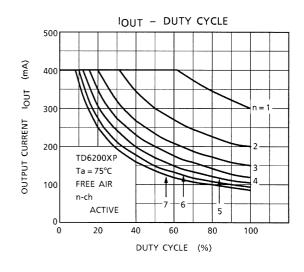
This IC does not include built-in protection circuits for excess current or overvoltage.

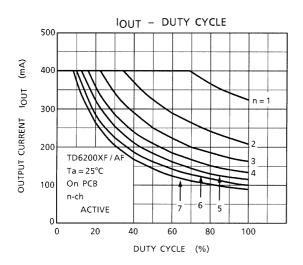
If this IC is subjected to excess current or overvoltage, it may be destroyed.

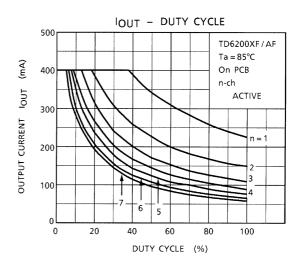
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

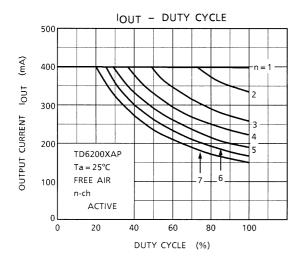
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

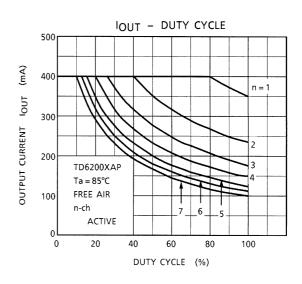


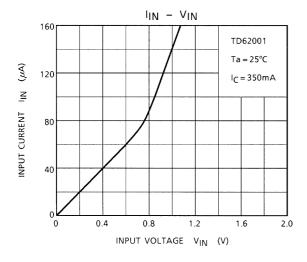


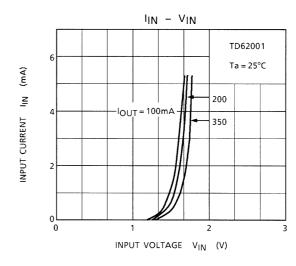


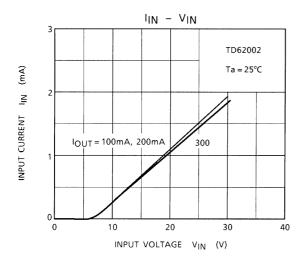


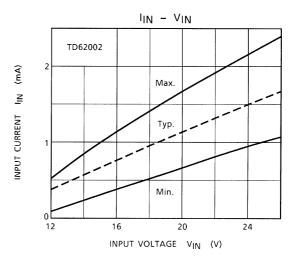


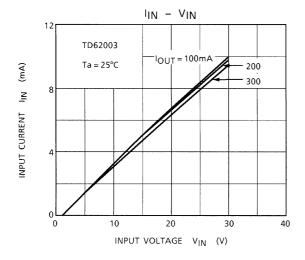


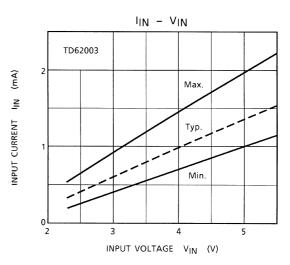


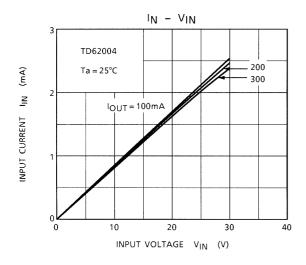


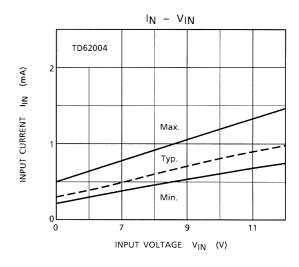


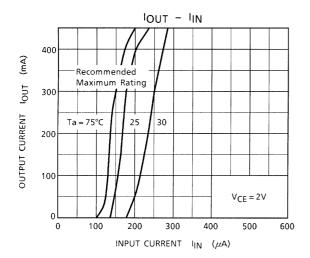


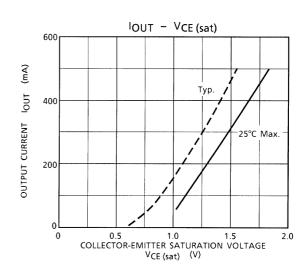


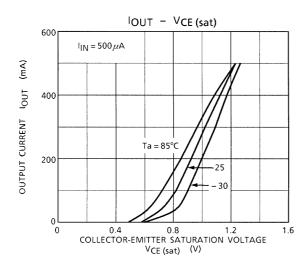


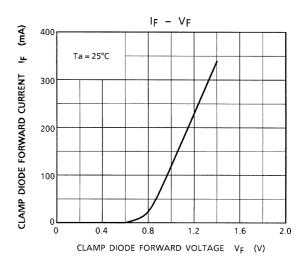


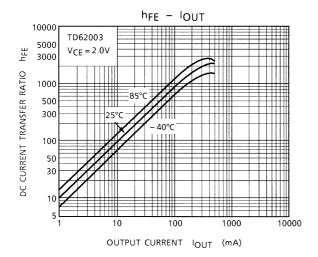


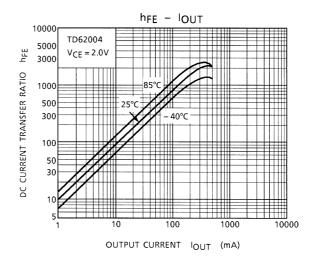


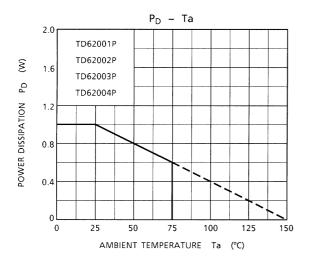


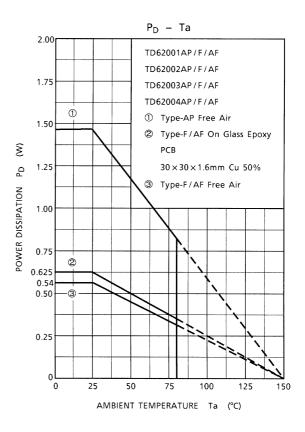






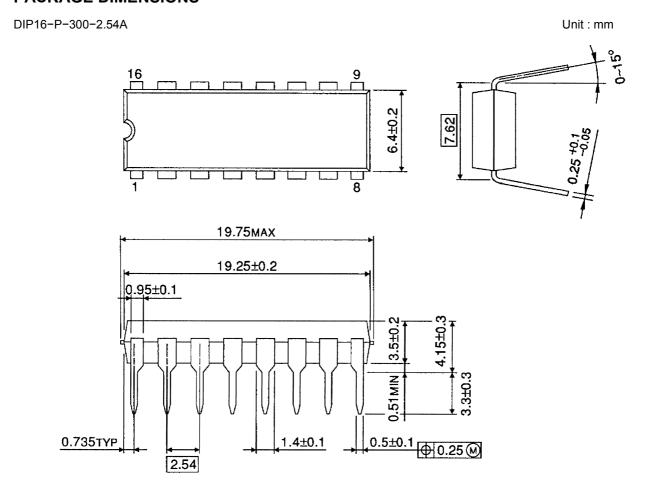






## **PACKAGE DIMENSIONS**

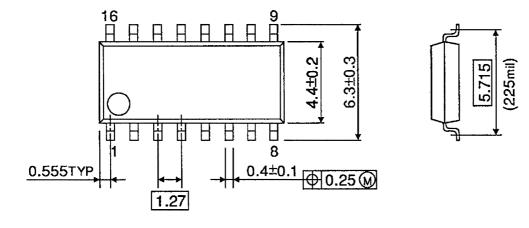
**TOSHIBA** 

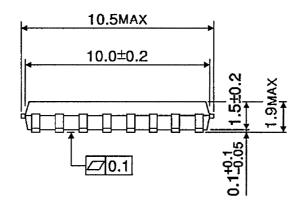


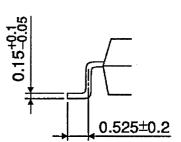
Weight: 1.11 g (Typ.)

## **PACKAGE DIMENSIONS**

SOP16-P-225-1.27 Unit: mm







Weight: 0.16 g (Typ.)

2001-06-27

#### **RESTRICTIONS ON PRODUCT USE**

000707EBA

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